

# n-channel enhancement— mode lateral D-MOS FETs



*designed for Military and Industrial Applications . . .*

- High Speed Switching
- Analog Switch
- Multiplexer
- Digital Switch
- A to D Converters
- D to A Converters
- Choppers
- Sample and Hold

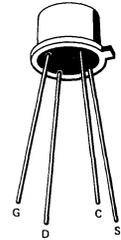
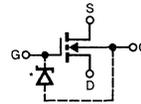
**BENEFITS**

- High Speed Switching
- Ultra Low Feedback Capacitance
- Low  $R_{DS(ON)}$
- Diode Protected Gate

**ABSOLUTE MAXIMUM RATINGS (°C)**

Drain Current ..... 50 mA  
 Total Device Dissipation at 25°C  
 Case Temperature ..... 1.2W  
 Storage Temperature Range ..... -65° to +150°C  
 Lead Temperature  
 (1/16" from case for 10 sec)..... 300°C  
 Operating Temperature Range ..... -55° to +150°C

TO-72  
See Section 6



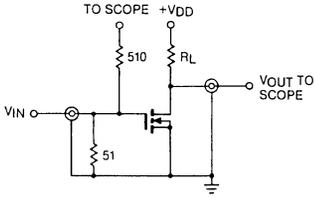
**ELECTRICAL CHARACTERISTICS (25°C unless otherwise noted)**

Characteristic—DC		Min	Typ	Max	Unit	Test Conditions
$I_{GSS}$	Gate Reverse Current		0.1	1	$\mu A$	$V_{GS} = 20V, V_{DS} = V_{GS} = V_{BS} = 0$
$B_{VSD}$	Breakdown Voltage Source to Drain	10			V	$V_{GD} = V_{BD} = -5V, I_D = 1 \mu A$
$B_{VSB}$	Breakdown Voltage Source to Body	10			V	$I_S = 10 \mu A, V_{GB} = 0$
$B_{VDS}$	Breakdown Voltage Drain to Source	15			V	$V_{GS} = V_{BS} = 0V, I_D = 10 \mu A$
$V_{GS(th)}$	Gate-Source Threshold Voltage	0.5		2.5	V	$V_{DS} = V_{GS} = V_{th}, I_D = 10 \mu A$
$g_{fs}$	Common-Source Forward Transconductance	25	30		mmhos	$V_{DS} = 15V, I_D = 20 mA, F = 1 KHz$
$R_{DS(ON)}$	Drain to Source Resistance			18	$\Omega$	$I_D = 5 mA, V_{BS} = 0V$
				12	$\Omega$	$V_{GS} = 5V$
			8		$\Omega$	$V_{GS} = 10V$ $V_{GS} = 15V$
Characteristic—AC		Min	Typ	Max	Unit	Test Conditions
Small Signal Capacitance						$V_{DS} = 10V, V_{GS} = V_{BS} = -15V, f = 1 MHz$
$C_{(GS+GD+GB)}$	Gate Mode			17	pF	
$C_{(GD+DS)}$	Drain Mode			7	pF	
$C_{DG}$	Reverse Transfer			2.5	pF	

**SWITCHING CHARACTERISTICS**

**TEST CONDITIONS**

**Switching**

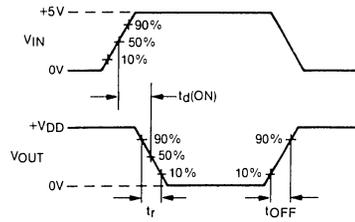


Input pulse  $t_d, t_r < 1\text{ns}$   
 Pulse width = 100ns  
 Rep rate = 1 MHz

**SAMPLING SCOPE**

$t_r < 360\text{ps}$   
 $R_{IN} = 1\text{M}\Omega$   
 $C_{IN} = 2.0\text{pF}$

**Typical Switching Waveform**



**SWITCHING CHARACTERISTICS**

VDD	RL	td(ON) (ns)		tr(ns)		tOFF(ns)	
		Typ	Max	Typ	Max	Typ	Max
5	680	0.6	1.0	0.7	1.0	9.0	*
10	680	0.7	1.0	0.8	1.0	9.0	*
15	1k	0.9	1.0	1.0	1.0	14.0	*

\*tOFF is dependent on RL and CL and does not depend on the device characteristics